



# Product Change Notification

**Change Notification #:** 115117 - 01  
**Change Title:** Select Intel® SSD DC P3520 Series Products, PCN 115117-01, Product Design, Firmware Update  
**Reason for Revision:** Update Firmware And Customer Ready to Receive Date  
**Date of Publication:** February 27, 2017

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	March 27, 2017
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**Reason for Revision:** The firmware for the Intel® SSD DC P3520 Series will be updated from MDV10270 to MDV10271. The TA and SA #s have been updated in the Products Affected/Intel Ordering Codes table. The Customer Must be Ready to Receive Post-Conversion Material from the updated date of March 27, 2017 and on. No other changes have been made to the PCN.

## Description of Change to the Customer:

The Intel® SSD DC P3520 Series firmware version is being updated from MDV10253 to MDV10271. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

## Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware update.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX020T701	943972	H83920-004	H83921-004	<a href="#">H83920-006</a>	<a href="#">H83921-006</a>
Intel® SSD DC P3520 Series (1.2TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX012T701	943973	H83923-004	H83924-004	<a href="#">H83923-006</a>	<a href="#">H83924-006</a>
Intel® SSD DC P3520 Series (2.0TB, 1/2 Height PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPEDMX020T701	943974	H83906-003	H83907-003	<a href="#">H83906-005</a>	<a href="#">H83907-005</a>
Intel® SSD DC P3520 Series (1.2TB, 1/2 Height PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPEDMX012T701	943979	H83914-003	H83915-003	<a href="#">H83914-005</a>	<a href="#">H83915-005</a>
Intel® SSD DC P3520 Series (1.2TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX012T710	943981	H83925-004	H83924-004	<a href="#">H83925-006</a>	<a href="#">H83924-006</a>
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX020T710	943982	H83922-004	H83921-004	<a href="#">H83922-006</a>	<a href="#">H83921-006</a>
Intel® SSD DC P3520 Series (450GB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX450G701	948646	J13467-003	J13469-003	<a href="#">J13467-005</a>	<a href="#">J13469-005</a>

### PCN Revision History:

**Date of Revision:**

February 9, 2017

[February 27, 2017](#)

**Revision Number:**

00

[01](#)

**Reason:**

Originally Published PCN

[Firmware Update](#)



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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